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August 2009

FSHDMI08 — Low-Voltage, Wide-Bandwidth, HDMI Switch with DDC and CEC Multiplexer

Features

- -25db Non-Adjacent Channel Crosstalk at 1.65Gbps
- Low Signal Loss: -1.5dBg attenuation at 1.65Gbps
- Isolation Ground Between Channels
- Fast Turn-on/off Time (< 6ns)</p>
- 1.65Gbps Throughput
- 8kV ESD Protection
- Low Skew: Intra-pair <90ps, Inter-pair < 150ps
- Low Power Consumption: 1µA Maximum

Applications

XGA and 720p DVI and HDMI Video Source Selection

Description

The FSHDMI08 is a wide-bandwidth switch designed for routing HDMI link data, clock, and the relevant DDC and CEC control signals that support the data rate up to 1.65Gbps per channel for UXGA resolution. Applications include LCD TVs, DVD, set-top boxes, and notebook designs with multiple digital video interfaces.

This switch allows the passage of HDMI link signals with ultra-low non-adjacent channel crosstalk and ultra-low off isolation. This is critical to minimize ghost images between active video sources in video applications. The wide bandwidth of this switch allows the high-speed differential signal to pass through with minimal additive skew and phase jitter. The pinout supports an HDMI standard-A connector PCB layout.

IMPORTANT NOTE:

For additional information, please contact analogswitch@fairchildsemi.com.

Ordering Information

Order Number	© Eco Status	Package Description	Packing Method	
FSHDMI08MTDX RoHS		56-Lead, Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide	Tape and Reel	

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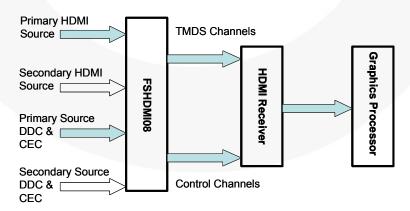


Figure 1. Single-Link HDMI Application

Functional Diagram

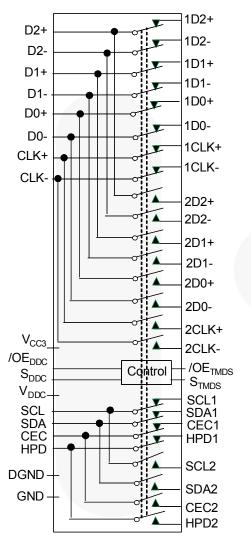


Figure 2. Functional Diagram

Pin Descriptions

Pin	Name	Description	
1-4,6,7,11-14,16,17, 47,48,50,51,53,54	1Dn+, 1Dn-, 2Dn+, 2Dn-, Dn+, Dn-	TMDS Data Channels	
8,9,18,19,44,45	1CLK+, 1CLK-, 2CLK+, 2CLK-, CLK+, CLK-	TMDS Clock Channels	
24,28,33	HPD1, HPD2, HPD	Hot Plug Detects	
22,26,35	SCL1, SCL2, SCL	Serial Clock (DDC)	
23,27,34	SDA1, SDA2, SDA	Serial Data (DDC)	
21,25,36	CEC1, CEC2, CEC	Consumer Electronics Control (CEC)	
29	V _{DDC}	DDC Power	
20,39,40,55,56	V _{CC3}	TMDS Power	
30	DGND	DDC/CEC GND	
5,10,15,38,43,46,49,52	GND	GND	
32,42	S _{TMDS} , S _{DDC}	Select Pins (TMDS, DDC)	
31,41	/OE _{TMDS} , /OE _{DDC}	Output Enable (TMDS, DDC)	

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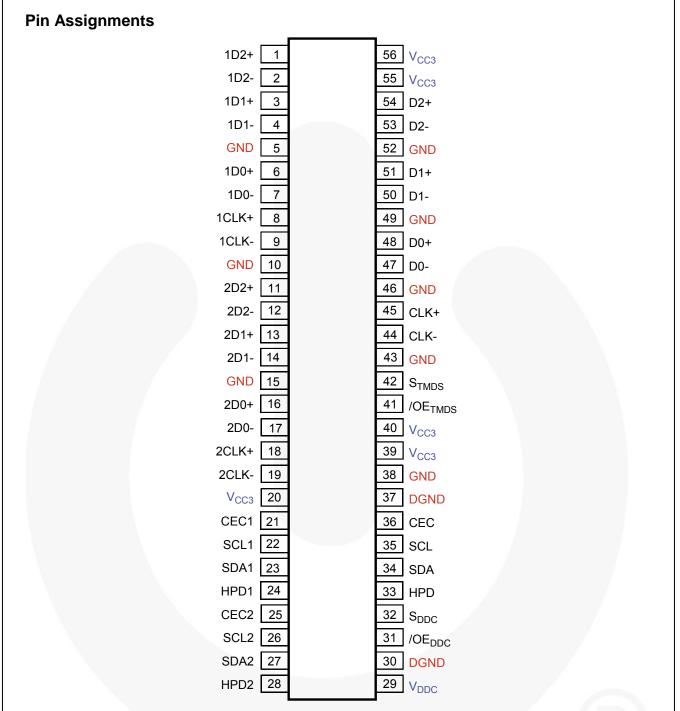


Figure 3. Pin Assignments

Truth Table

S _{TMDS} , S _{DDC}	/OE _{TMDS} ,	Function
Don't' Care	Logic Level HIGH	All Ports Disconnected (Hi-Z)
Logic Level LOW	Logic Level LOW	1Dn+/1Dn-=Dn+/Dn-; 1CLK+/ 1CLK-=CLK+/CLK-; HPD1=HPD; SCL1=SCL; SDA1=SDA; CEC1=CEC
Logic Level HIGH	Logic Level LOW	2Dn+/2Dn-=Dn+/Dn-; 2CLK+/ 2CLK-=CLK+/CLK-; HPD2=HPD; SCL2=SCL; SDA2=SDA; CEC2=CEC

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter				Max.	Unit
V _{CC3}	Supply Voltage – TMDS Channels			-0.5	4.6	V
V_{DDC}	Supply Voltage – 5V DI	С		-0.5	6.0	V
V _{SWTMDS} ⁽¹⁾	Switch I/O Voltage	1Dn+, 1Dn-, 2Dn+, 2Dn 1CLK-, 2CLK+, 2CLK-,		-0.5	V _{CC3} + 0.3	٧
V _{SWDDC} ⁽¹⁾	Switch I/O Voltage	HPD1, HPD2, HPD, SO SDA1, SDA2, SDA, CE		-0.5	V _{DDC} + 0.3	٧
V _{CNTRLT} ⁽¹⁾	Control Input Voltage	S _{TMDS} , /OE _{TMDS}		-0.5	4.6	V
V _{CNTRLD} ⁽¹⁾	Control Input Voltage	S _{DDC} , /OE _{DDC}	-0.5	6.0	V	
I _{IK}	Input Clamp Diode Current				-50	mA
I _{SW}	Switch I/O Current (Continuous)				128	mA
T _{STG}	Storage Temperature Range			-65	+150	°C
TJ	Maximum Junction Terr	perature			+150	°C
T_L	Lead Temperature (Soldering, 10 Seconds)				+260	°C
	II B. I M. I I / I		I/O to GND	1	8.0	
ESD	Human Body Model (JE	:DEC: JESD22-A114)	All Other Pins		2.5	kV
	Charged Device Model (JEDEC: JESD22-C101)				2.0	

Note:

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{CC3}	TMDS Supply Voltage – 3V	3.0	4.3	V
V_{DDC}	DDC Supply Voltage	3.0	5.5	V
V _{CNTRLT}	Control Input Voltage – S _{TMDS} , /OE _{TMDS}	0	V _{CC3}	V
V _{CNTRLD}	Control Input Voltage – S _{DDC} , /OE _{DDC}	0	V_{DDC}	V
V_{SWTMDS}	Switch I/O Voltage for HDMI path	V _{CC3} – 0.6	V_{CC3}	V
V_{SWDDC}	Switch I/O Voltage for DDC path	0	V_{DDC}	V
T _A	Operating Temperature	-40	+85	°C
$\theta_{\sf JA}$	Thermal Resistance (Free Air)		+80	°C/W

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The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

DC Electrical Characteristics

All typical values are for V_{CC3} =3.3V and V_{DDC} =5.0V at 25°C unless otherwise specified.

Symbol	Damamatan	V (V 00	Conditions T _A =- 40°C	l0°C to	+85°C	Unit		
Symbol	Parameter V _{CC3} / V _{DDC} (V) Cor		Conditions	Min.	Тур.	Max.	Unit	
V _{IK}	Clamp Diode Voltage	V _{CC3} =3.0 V _{DDC} =5.0	I _{IN} =-18mA			-1.2	٧	
V _{IH}	Control Input Voltage High	V _{CC3} =3.0 to 3.6 V _{DDC} =3.0 to 5.5		2			٧	
V _{IL}	Control Input Voltage Low	V _{CC3} =3.0 to 3.6 V _{DDC} =3.0 to 5.5				0.8	V	
I _{OZTMDS}	Off State Leakage TMDS Channels	V _{CC3} =3.6 V _{DDC} =5.5	$0 \le V_{SWTMDS} \le V_{CC3}$ Figure 5	-1		1	μΑ	
I _{OZDDC}	Off State Leakage DDC/CEC Channels	V _{CC3} =3.6 V _{DDC} =5.5	$0 \le V_{SWDDC} \le V_{DDC}$ Figure 5	-5		5	μΑ	
I _{INTMDS}	Control Input Leakage (S _{TMDS} , /OE _{TMDS})	V _{CC3} =3.6 V _{DDC} =5.5	V _{SWDDC} =0 to V _{CC3}	-1		1	μA	
I _{INDDC}	Control Input Leakage (S _{DDC} , /OE _{DDC})	V _{CC3} =3.6 V _{DDC} =5.5	V _{SWDDC} =0 to V _{DDC}	-1		1	μA	
I _{CC3}	Quiescent Supply Current -TMDS	V _{CC3} =3.6 V _{DDC} =5.5	$V_{SWTMDS}=V_{CC3}-0.6$ or V_{CC3} , $I_{OUT}=0$			2	μA	
I _{DDC}	Quiescent Supply Current -DDC	V _{CC3} =3.6 V _{DDC} =5.5	V_{SWDDC} =0 or V_{DDC} , I_{OUT} =0			2	μA	
ΔІсстз	Increase in I _{CC3}	V _{CC3} =3.6 V _{CC5} =5.5	One input at 3.0V; Other inputs at V _{CC3} - 0.6 or V _{CC3}			100	μΑ	
Δl _{CCTD}	Increase in I _{DDC}	V _{CC3} =3.6 V _{CC5} =5.5	One input at 3.0V; Other inputs at V _{DDC}			15	μA	

AC Electrical Characteristics

All typical values are for V_{CC3} =3.3V and V_{DDC} =5.0V at 25°C unless otherwise specified.

Cumbal	Parameter	V _{CC3} / V _{DDC} (V)	Conditions	T _A =- 40°C to +85°C			1154
Symbol			Conditions	Min.	Тур.	Max.	Uni
TMDS Chan	nels						
t _{ONTMDS}	Turn-On Time S, /OE to Output	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	$V_{SWTMDS}=V_{CC3}$ -0.5, $R_{PU}=50\Omega$, $C_L=5pf$		4	6	
	o, /or to output	VDDC -3.0	Figure 6, Figure 7				ns
t _{OFFTMDS}	Turn-Off Time S to Output	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	$V_{SWTMDS}=V_{CC3}$ -0.5, $R_{PU}=50\Omega$, $C_L=5pf$		2	4	110
	O to Output	VDDC -0.0	Figure 6, Figure 7				
t _{BBM-TMDS}	Break-Before-Make	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	$V_{SWTMDS}=V_{CC3}$ -0.5, $R_{PU}=50\Omega$, $C_L=5pf$	1			ns
	111110	VDDC 0.0	Figure 15				
$t_{pd} (t_{pLH}, t_{pHL})$	Switch Propagation	V _{CC3} =3.0 to 3.6	R_{PU} =50 Ω , C_L =5pf			400	ps
-pu (*pin,*pni)	Delay ⁽²⁾	V _{DDC} =5.0	Figure 14			.30	μs
t _{jitter}	Total Jitter (DJ+RJ)	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	f=165MHz clock with 50% duty cycle, R_{PU} =50 Ω , C_L =5pf			90	ps
			Figure 14				
t_{ratio}	Duty Cycle Ratio	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	f=165MHz clock with 50% duty cycle, R_{PU} =50 Ω , C_L =5pf	40	50	60	%
			Figure 14				
t _{sĸ1}	Intra-Pair Skew (TMDS Cn+ to Cn-)	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	f=1.65Gbps, 2 ²³ -1 PRBS, R _{PU} =50Ω, C _L =5pf		55	100	ps
	CII+ to CII-)	VDDC -3.0	Figure 14				
t _{sk2}	Inter-Pair Skew (Between any two TMDS switch pair	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	f=1.65Gbps, 2^{23} -1 PRBS, R_{PU} =50Ω, C_L =5pf		90	160	ps
	paths)		Figure 14				
		V _{CC3} =3.0 to 3.6	R_T =50 Ω , f=370MHz	-30			
OIRR _{TMDS}	Off-Isolation	V _{DDC} =5.0	Figure 10	-30			dB
OIITITIMUS	(TMDS Channels)	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	R_T =50 Ω , f=825MHz Figure 10	-25			uБ
	Non-Adjacent Channel Crosstalk (TMDS Channels)	V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	R_T =50 Ω , f=370MHz Figure 11	-25			
Xtalk _{TMDS}		V _{CC3} =3.0 to 3.6 V _{DDC} =5.0	R_T =50 Ω , f=825MHz Figure 11	-20			dB
f _{max}	Maximum Throughput ⁽²⁾	V _{CC3} =3.3 V _{DDC} =5.0	Tigure 11		1.65		Gbp
Control Cha	nnels – DDC / CEC				1		
tonddc	Turn-On Time; S _{DDC} , /OE _{DDC} to Output	V _{CC3} =3.3 V _{DDC} =3.0 to 5.5	V_{SWDDC} =2V, R_{DDC} =1k Ω , C_L =5pf			28	ns
t _{OFFDDC}	Turn-Off Time; S _{DDC} , /OE _{DDC} to Output	V _{CC3} =3.3 V _{DDC} =3.0 to 5.5	V_{SWDDC} =2V, R_L =1k Ω , C_L =5pf			24	ns

Note:

2. Guaranteed by characterization, not production tested.

Test Diagrams

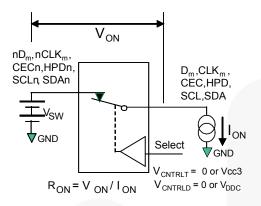
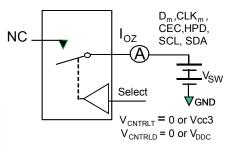


Figure 4. On Resistance



Each switch port is tested separately.

Figure 5. Off Leakage

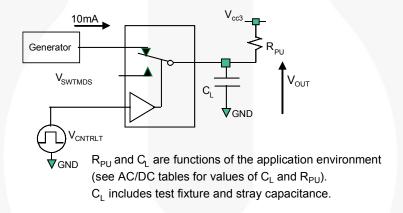


Figure 6. TMDS Test Circuit Load

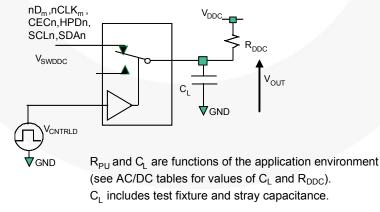
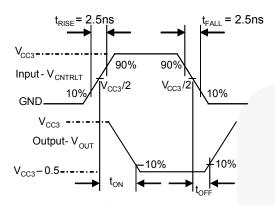


Figure 7. DDC Test Circuit Load

Test Diagrams



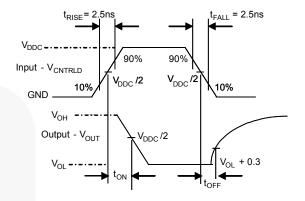


Figure 8. Turn-on / Turn-off Waveforms

Figure 9. DDC Turn-on / Turn-off Waveforms

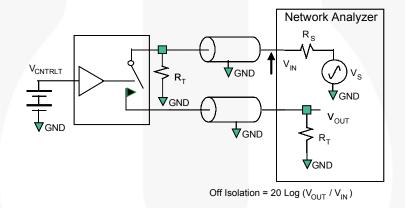


Figure 10. Channel Off Isolation

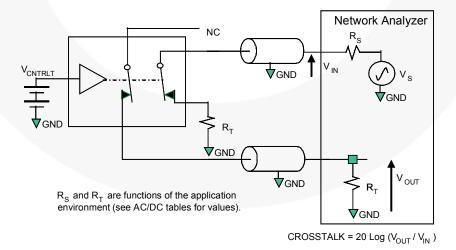


Figure 11. Non-Adjacent Channel-to-Channel Crosstalk

Test Diagrams

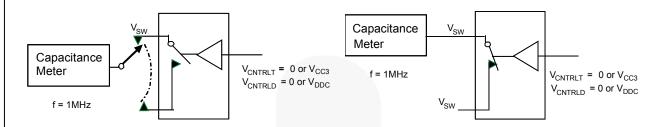


Figure 12. Channel Off Capacitance

Figure 13. Channel On Capacitance

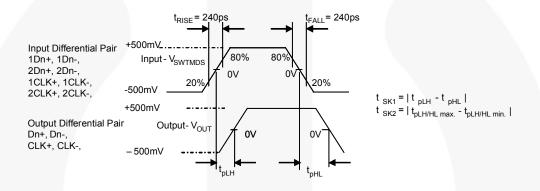


Figure 14. Intra- and Inter-Pair Skew tpd

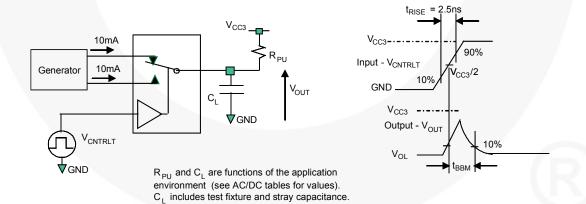


Figure 15. Break Before Make

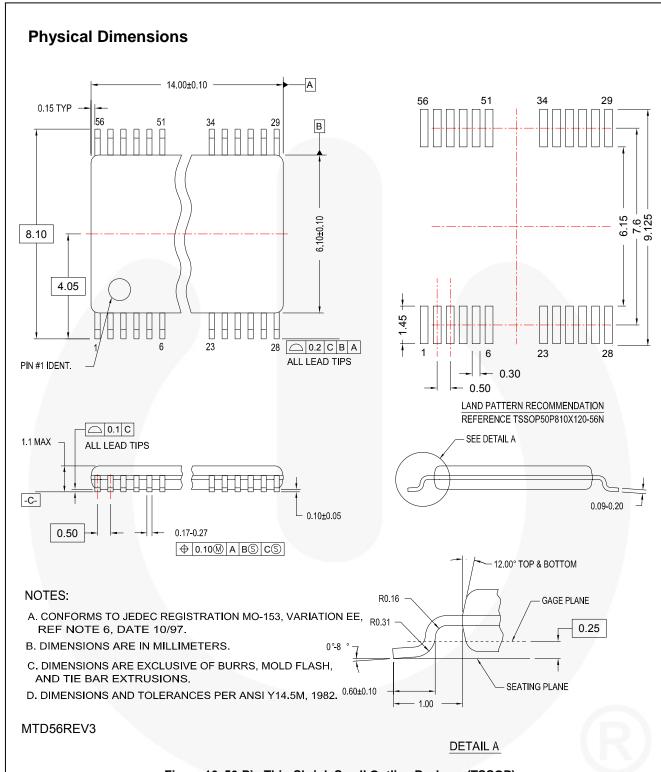


Figure 16. 56-Pin Thin-Shrink Small Outline Package (TSSOP)

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Definition of Torms

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